

Title (en)

Tile with connection means, and process for laying such tile

Title (de)

Fliese mit Verbindungsmittel und Verfahren zur deren Verlegung

Title (fr)

Carreau avec moyen de connection et procédé pour poser de tels carreaux

Publication

EP 1154097 A1 20011114 (EN)

Application

EP 01110970 A 20010507

Priority

IT TO20000434 A 20000511

Abstract (en)

A tile (1) is disclosed that is equipped with connection means (3), which are adapted to connect the tile (1) to immediately-adjacent tiles (1) thereby obtaining a complete seal against seepages of foreign substances into spaces between adjacent tiles (1). In particular, the connection means are composed of at least one band of plastic or tin material placed around the tile (1). A process is further disclosed for laying such tiles (1). <IMAGE>

IPC 1-7

E04F 15/02; **E04B 1/61**

IPC 8 full level

E04F 15/02 (2006.01)

CPC (source: EP)

E04F 15/02011 (2013.01); **E04F 15/02016** (2013.01)

Citation (search report)

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